



ProLight PM2F-3LLx-SD 3W UV Power LED Technical Datasheet Version: 1.0

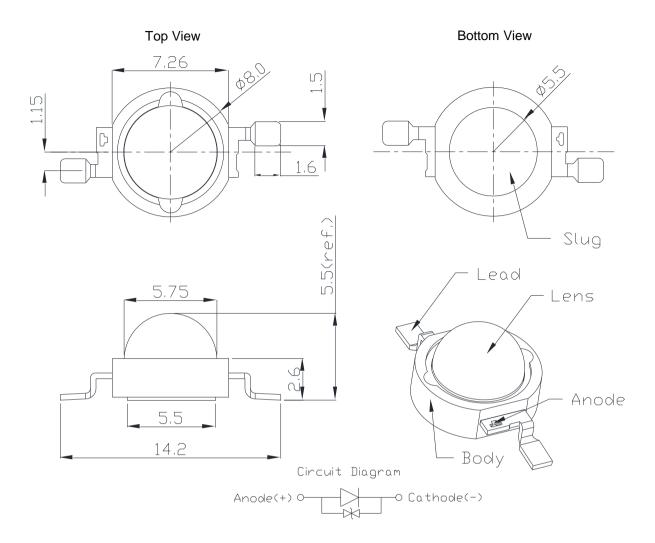
Features

- Instant light (less than 100ns)
- Low-temp. & lead free reflow soldering
- RoHS compliant
- Cool beam, safe to the touch

Typical Applications

- UV gluing, UV curing, UV marking
- UV drying of printing inks and lacquers
- Currency inspection
- Forensic analysis urine, protein stains
- Leak detection using fluorescent dyes
- Detects fluorescing minerals and gems
- Indoor Lighting
- Outdoor Lighting

Emitter Mechanical Dimensions

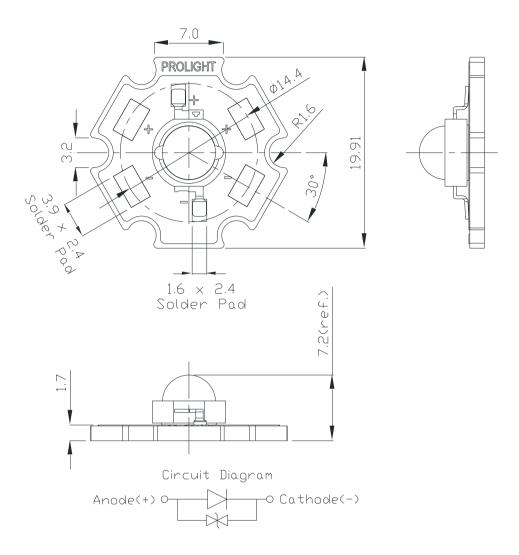


Notes:

- 1. The Anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required. Do not electrically connect either the anode or cathode to the slug.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.
- 5. Unless otherwise indicated, tolerances are $\pm\,0.20\mbox{mm}.$
- 6. Please do not bend the leads of the LED, otherwise it will damage the LED.
- 7. Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

*The appearance and specifications of the product may be modified for improvement without notice.

Star Mechanical Dimensions



Notes:

- 1. Slots in aluminum-core PCB for M3 or #4 mounting screw.
- 2. Electrical interconnection pads labeled on the aluminum-core PCB with "+" and "-" to denote positive and negative, respectively. All positive pads are interconnected, as are all negative pads, allowing for flexibility in array interconnection.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.
- 5. Unless otherwise indicated, tolerances are \pm 0.20mm.
- 6. Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

*The appearance and specifications of the product may be modified for improvement without notice.

Flux Characteristics, T_J = 25°C

Radiometric Power (mW) **Part Number** @700mA Refer @350mA Radiation Color **Pattern Emitter** Star **Minimum Typical Typical** Lambertian UV PM2F-3LLE-SD PM2F-3LLS-SD 1050 1300 640

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics, T_J = 25°C

Forward Voltage V _F (V)					
Color	Min.	@700mA Typ.	Max.	Refer @350mA Typ.	Thermal Resistance Junction to Slug (°C/ W)
UV	3.10	3.70	4.35	3.30	8

ullet ProLight maintains a tolerance of \pm 0.1V for Voltage measurements.

Optical Characteristics at 700mA, T_J = 25°C

				Total included Angle	Viewing Angle
Color	Pe Min.	eak Wavelength <i>i</i> Typ.	N _P Max.	(degrees) $\theta_{0.90V}$	(degrees) 2 θ _{1/2}
UV	390 nm	400 nm	410 nm	180	130

[•] ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

Absolute Maximum Ratings

Parameter	UV
DC Forward Current (mA)	700
Peak Pulsed Forward Current (mA)	1000 (less than 1/10 duty cycle@1KHz)
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	> ±500V
LED Junction Temperature	120°C
Operating Board Temperature at Maximum DC Forward Current	-40°C - 100°C
Storage Temperature	-40°C - 120°C
Soldering Temperature	JEDEC 020c 240°C
Allowable Reflow Cycles	3
Reverse Voltage	Not designed to be driven in reverse bias

Radiometric Power Bin Structure at 700mA

	Color	Bin Code	Minimum Radiometric Power (mW)	Maximum Radiometric Power (mW)	Available Color Bins
Ī		V	1050	1225	2,3,4 [1]
	UV	W	1225	1400	[1]
Į		Х	1400	1680	[1]

- ullet ProLight maintains a tolerance of \pm 7% on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

Peak Wavelength Bin Structure

Color	Bin Code	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)
	1	390	395
UV	2	395	400
	3	400	405
	4	405	410

[•] ProLight maintains a tolerance of ± 1nm for peak wavelength measurements.

Forward Voltage Bin Structure at 700mA

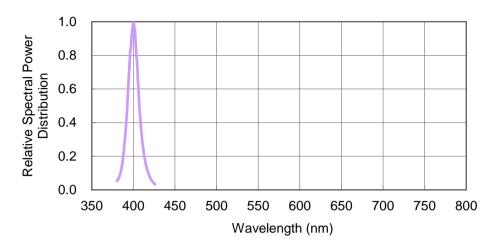
_	Color	Bin Code	Minimum Voltage (V)	Maximum Voltage (V)
		В	3.10	3.35
		D	3.35	3.60
	UV	E	3.60	3.85
		F	3.85	4.10
		G	4.10	4.35

ullet ProLight maintains a tolerance of \pm 0.1V for Voltage measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

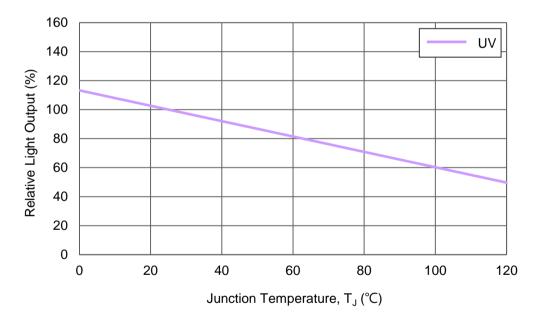
Color Spectrum, $T_J = 25^{\circ}C$

1. UV



Light Output Characteristics

Relative Light Output vs. Junction Temperature at 700mA



Forward Current Characteristics, $T_J = 25^{\circ}C$

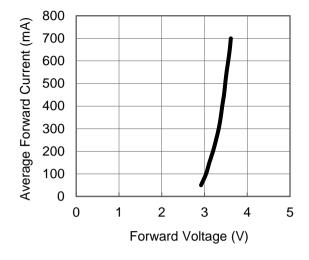
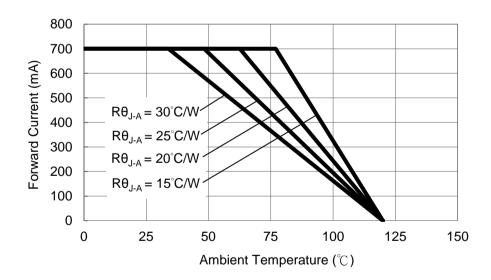


Fig 1. Forward Current vs. Forward Voltage

Fig 2. Relative Radiometric Power vs. Forward Current at $T_1=25^{\circ}$ maintained.

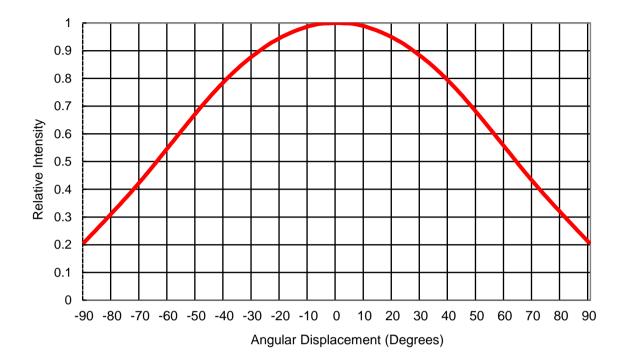
Ambient Temperature vs. Maximum Forward Current

1. UV $(T_{JMAX} = 120^{\circ}C)$



Typical Representative Spatial Radiation Pattern

Lambertian Radiation Pattern



Qualification Reliability Testing

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, I _F = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Operating Life (WHTOL)	85°C/60%RH, I _F = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Storage Life (WHTSL)	85°C/85%RH, non-operating	1000 hours	Note 2
High Temperature Storage Life (HTSL)	110°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 120°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C ± 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

Notes:

1. Depending on the maximum derating curve.

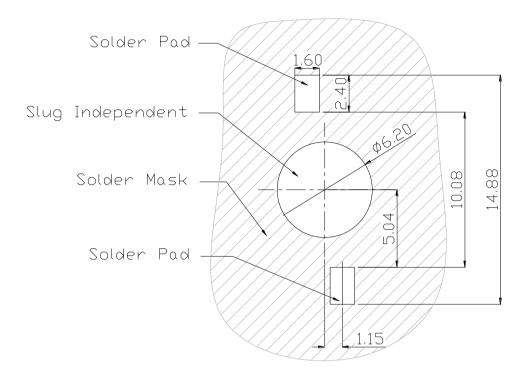
2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement		
item	rest Condition	Min.	Max.	
Forward Voltage (V _F)	I _F = max DC	-	Initial Level x 1.1	
Luminous Flux or Radiometric Power (Φ_V)	I _F = max DC	Initial Level x 0.7	-	

^{*} The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

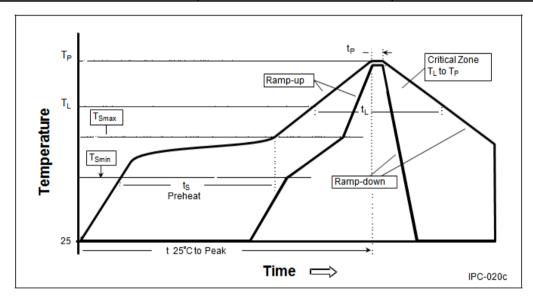
Recommended Solder Pad Design



- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.

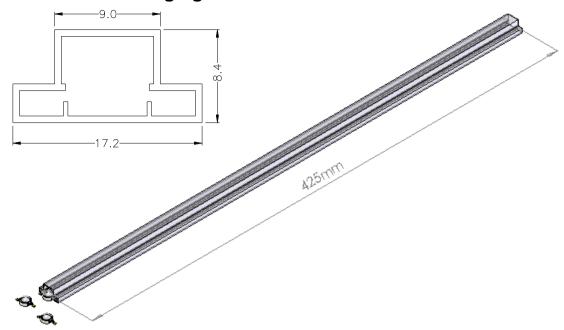
Reflow Soldering Condition

Profile Feature	Sn-Pb Eutectic Assembly	Low-Temp. & Pb-Free Assembly (58Bi-42Sn Eutectic Alloy)
Average Ramp-Up Rate $(T_{Smax} \text{ to } T_P)$	3°C / second max.	2°C / second max.
Preheat - Temperature Min (T _{Smin})	100°C	90°C
- Temperature Max (T _{Smax})	150°C	120°C
- Time (t _{Smin} to t _{Smax}) Time maintained above: - Temperature (T _L)	60-120 seconds 183°C	60-120 seconds 138°C
– Time (t _L)	60-150 seconds	20-50 seconds
Peak/Classification Temperature (T _P)	240°C	185°C
Time Within 5°C of Actual Peak Temperature (t _P)	10-30 seconds	10-30 seconds
Ramp-Down Rate	6°C/second max.	3°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	4 minutes max.

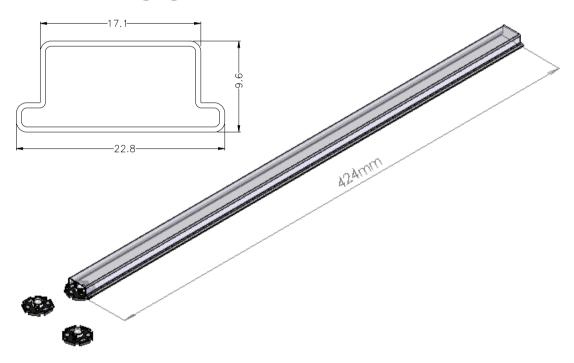


- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

Emitter Tube Packaging



Star Tube Packaging



Notes:

- 1. Emitter 50 pieces per tube and Star 20 pieces per tube.
- 2. Drawing not to scale.
- 3. All dimensions are in millimeters.
- 4. All dimendions without tolerances are for reference only.

^{**}Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH.

Precaution for Use

- Storage
 - Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.
- The slug is is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. http://www.prolightopto.com/

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